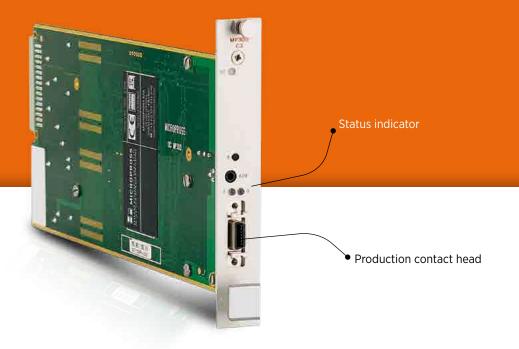


MP300 C3

A MULTIPROTOCOL CONTACT TESTER



SUPPORTED PROTOCOLS:

- ▶ ISO 7816
- SWP
- ▶ USB 2.0

APPLICATION FIELDS:

- Personalization
- Pre-personalization
- OS loading
- Electrical testing

ELECTRICAL TESTS COVERED:

- ▶ Open/Short
- Leakage current
- Chip consumption
- Drivability
- Current & voltage
- ▶ SWP S2 current value
- Vforce/Iforce
- Accurate definition of the test-conditions

Business areas



Telecom















- Possibility to install up to 4 MP300 C3 modules on the same mother board
- Support of the ISO/IEC 7816-3 and 4 protocols
- Full implementation of the T=0 and T=1 protocols
- Support of numerous memory chips
- Open for implementation of custom protocols
- Support of the fastest smartcards
- Fast hardware assisted data transmission mechanism, ensuring the maximum throughput for CPU and memory modules
- Advanced electrical test and measurement features (open/short, leakage, chip consumption, ...)

SUPPORTED PROTOCOLS

▶ ISO/IEC 7816	
T=0 and T=1 protocols	100% implemented, managed by firmware and FPGA, accelerated by hardware
USB 2.0 (optionnal)	
Available speeds	Low speed, full speed
Classes	ISO/IEC 7816-12, mass storage, custom protocols
 SWP (ETSI TS 102 613 and TS 102 622) (or 	otionnal)
SWP transmission	Assisted by hardware
LLC layers support	ACT, CLT and S-HDLC realised by firmware
Synchronous chips (memory chips)	
Raw mode: implementation of custom pr	otocols and support of out of standard chips

PROGRAMMABLE PARAMETERS

PHYSICAL PARAMETERS	
▶ Voltages	
Vcc, Vol, Voh, Vil, Vih adjustables	
> Frequency	
ISO 7816 and MMC/SD clock frequency	10kHz to 20MHz (duty cycle adjustable between 30% and 70%)
Pin states : all pins are managed separately	·

ISO 7816 COMMUNICATION PARAMETERS

SWP communication parameters	
Available baudrates	106, 212, 424, 848 kbit/s, 1.6Mbit/s
Adjustable parameters	Activation time, P2, P3, S2 current detection level

AVAILABLE TESTS

AVAILABLE 12313	
ELECTRICAL TESTS	
Open/short test (all contacts, forced current adjustable)	
Leakage current measurement (all contacts)	
Voltage measurement (all contacts, static & dynamic modes)	
Current measurement (all contacts, static & dynamic modes)	
Parametric tests (V=f(I), I=f(V))	
SWP specific measurement functions (statistics on SWP C2 current values)	
Anti tearing test (simulate the chip's immunity against tearing from the reader)	
Timing measurement	
Personalization assisted by hardware	



